# UNISONIC TECHNOLOGIES CO., LTD

38N60-ML **Power MOSFET** 

# 38A, 600V N-CHANNEL **POWER MOSFET**

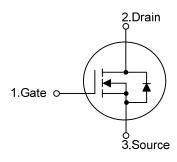
#### **DESCRIPTION**

The UTC 38N60-ML is a high voltage power MOSFET combines advanced planar MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

#### **FEATURES**

- \*  $R_{DS(ON)} \le 0.13 \Omega @ V_{GS} = 10V, I_D = 19A$
- \* High Switching Speed
- \* Lower gate charge results
- \* Enhanced dV/dt capabilities
- \* Higher gate voltage threshold

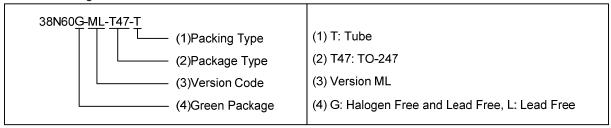
#### **SYMBOL**



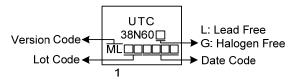
# **ORDERING INFORMATION**

Ordering Number		Daakana	Pin Assignment			Deelsina	
Lead Free	Halogen Free	Package	1	2	3	Packing	
38N60L-ML-T47-T	38N60G-ML-T47-T	TO-247	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



#### **MARKING**



TO-247

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# ■ ABSOLUTE MAXIMUM RATINGS (unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	600	V
Gate-Source Voltage		$V_{GSS}$	±30	V
Continuous Drain Current	Continuous	$I_D$	38	Α
	Pulsed	I <sub>DM</sub> 76		Α
Single Pulsed Avalanche Energy		E <sub>AS</sub>	484	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	7.3	V/ns
Power Dissipation		P <sub>D</sub>	540	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T <sub>STG</sub>	-55 ~ <b>+</b> 150	ů

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 1mH,  $I_{AS}$  = 38A,  $V_{DD}$  = 50V,  $R_G$  = 25 $\Omega$ , Starting  $T_J$  = 25 $^{\circ}$ C
- 4.  $I_{SD} \leq$  30A, di/dt  $\leq$  200A/ $\mu$ s,  $V_{DD} \leq$  BV $_{DSS}$ , Starting  $T_J$  = 25°C

#### **■ THERMAL DATA**

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	θја	40	°C/W	
Junction to Case	θјс	0.23	°C/W	

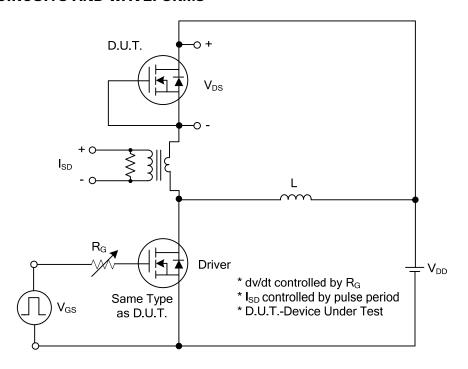
#### **■ ELECTRICAL CHARACTERISTICS**

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	600			V
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =600V, V <sub>GS</sub> =0V			10	μA
Gate-Source Leakage Current	Forward		V <sub>GS</sub> =+30V, V <sub>DS</sub> =0V			+100	nA
	Reverse	I <sub>GSS</sub>	V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V <sub>GS(TH)</sub>	$V_{DS}=V_{GS}$ , $I_D=250\mu A$	3.0		5.0	V
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =19A			0.13	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C <sub>ISS</sub>			9986		pF
Output Capacitance		Coss	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0MHz		771		pF
Reverse Transfer Capacitance		C <sub>RSS</sub>			102		pF
SWITCHING PARAMETERS							
Total Gate Charge		$Q_G$	\/ -490\/ \/ -40\/   -29A		198		nC
Gate to Source Charge		$Q_GS$	V <sub>DS</sub> =480V, V <sub>GS</sub> =10V, I <sub>D</sub> =38A (Note 1, 2)		53		nC
Gate to Drain Charge		$Q_GD$	(Note 1, 2)		59		nC
Turn-ON Delay Time		t <sub>D(ON)</sub>			128		ns
Rise Time		$t_R$	V <sub>DD</sub> =100V, V <sub>GS</sub> =10V, I <sub>D</sub> =38A,		41		ns
Turn-OFF Delay Time		$t_{D(OFF)}$	R <sub>G</sub> =25Ω (Note 1, 2)		461		ns
Fall-Time		$t_{F}$			90		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		Is				38	Α
Drain-Source Diode Forward Voltage		$V_{\text{SD}}$	I <sub>S</sub> =38A, V <sub>GS</sub> =0V			1.4	V
Body Diode Reverse Recovery Time		t <sub>rr</sub>	I <sub>S</sub> =30A, V <sub>GS</sub> =0V, dI <sub>F</sub> /dt=100A/μs		656		ns
Reverse Recovery Charge		$Q_{rr}$	(Note 1)		1.38		μC

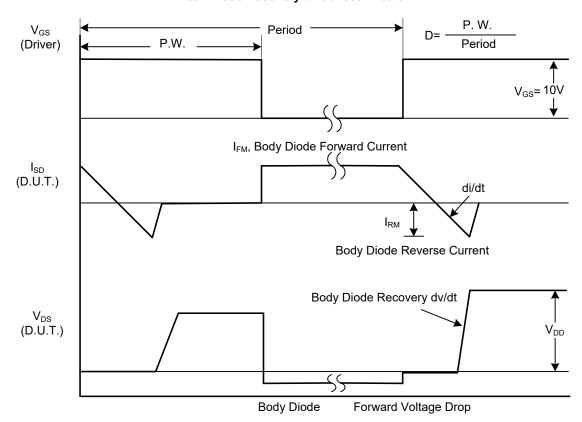
Notes: 1. Pulse Test: Pulse width  $\leq$  600 $\mu$ s, Duty cycle  $\leq$  2%.

2. Essentially independent of operating temperature.

#### ■ TEST CIRCUITS AND WAVEFORMS

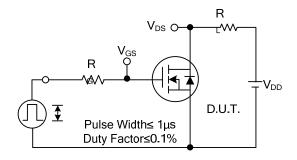


# Peak Diode Recovery dv/dt Test Circuit

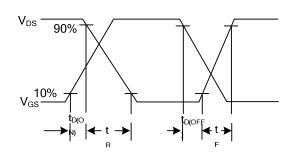


Peak Diode Recovery dv/dt Waveforms

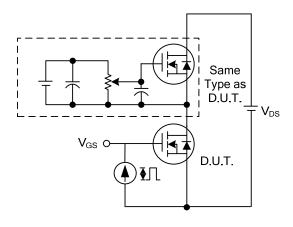
# **■ TEST CIRCUITS AND WAVEFORMS**



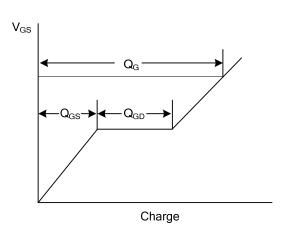
Switching Test Circuit



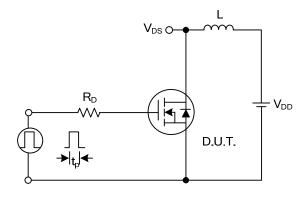
Switching Waveforms



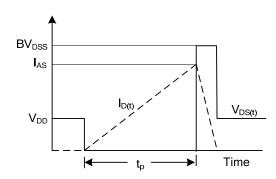
Gate Charge Test Circuit



Gate Charge Waveform

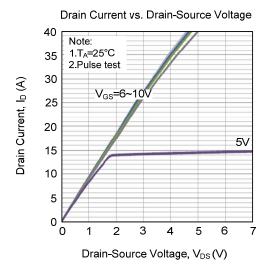


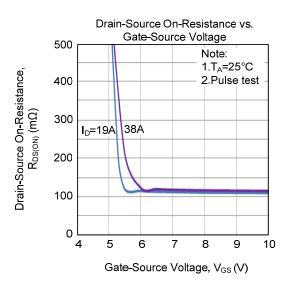
**Unclamped Inductive Switching Test Circuit** 

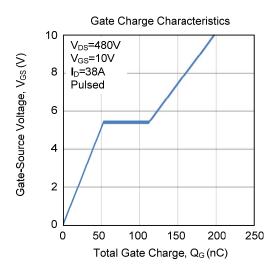


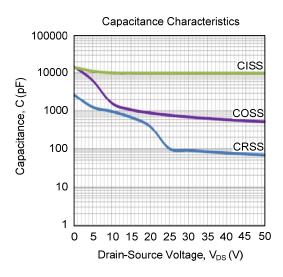
**Unclamped Inductive Switching Waveforms** 

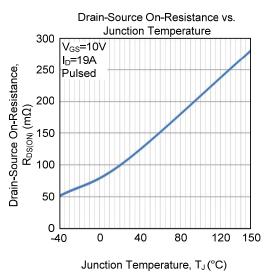
#### **■ TYPICAL CHARACTERISTICS**

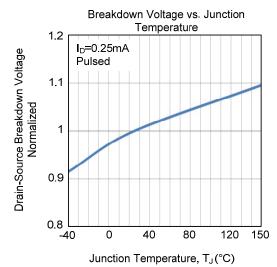




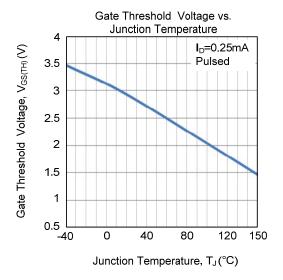


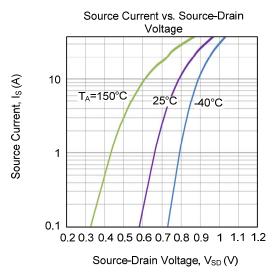


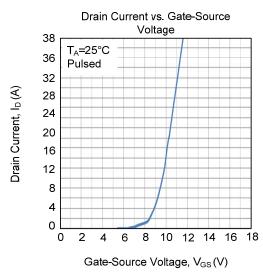


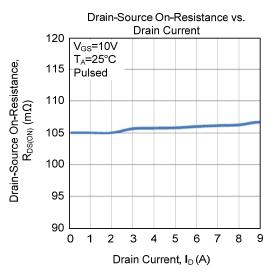


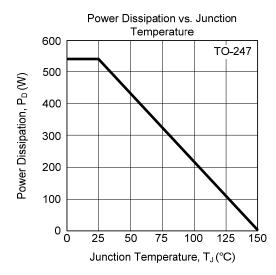
# **TYPICAL CHARACTERISTICS (Cont.)**

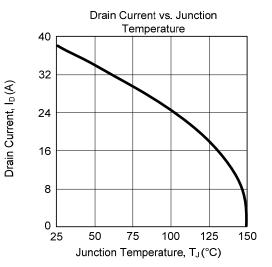




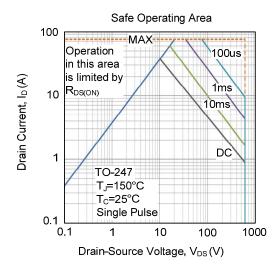


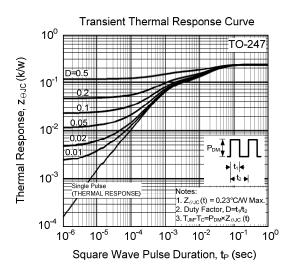






# **■ TYPICAL CHARACTERISTICS (Cont.)**





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